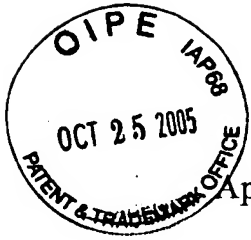


IFW



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Wen-Ching Chen :
Serial No: 10/662,433 : Art Unit #2878
Filed: 16 September 2003 : Examiner:
Title: CHIP SCALE PACKAGE : D. Williams
STRUCTURE FOR AN IMAGE

AMENDMENT

Honorable Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Official Action dated 28 July 2005, please amend the
above-identified Application as follows:

Amendments to the Claims are reflected in the Listing of Claims which
begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.